TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOS V)

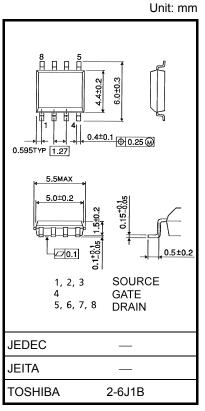
TPC8121

Notebook PC Applications Lithium Ion Battery Applications Portable Equipment Applications

- Small footprint due to small and thin package
- Low drain-source ON-resistance: $RDS(ON) = 8.0 \text{ m}\Omega \text{ (typ.)}$
- High forward transfer admittance: $|Y_{fs}| = 23 \text{ S (typ.)}$
- Low leakage current: $IDSS = -10 \mu A (max) (VDS = -30 V)$
- Enhancement mode: $V_{th} = -0.8$ to -2.0 V ($V_{DS} = -10$ V, $I_{D} = -1$ mA)

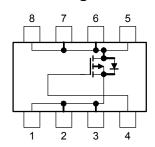
Absolute Maximum Ratings (Ta = 25°C)

Characteri	stics	Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	-30	V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	-30	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	ID	-11	Α	
	Pulse (Note 1)	I _{DP}	-44	A	
Drain power dissipatio	n (t = 10 s) (Note 2a)	P _D	1.9	W	
Drain power dissipation (t = 10 s) (Note 2b)		P _D	1.0	W	
Single pulse avalanche energy (Note 3)		E _{AS}	82	mJ	
Avalanche current		I _{AR}	-11	Α	
Repetitive avalanche energy (Note 2a) (Note 4)		E _{AR}	0.030	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature r	ange	T _{stg}	-55 to 150	°C	



Weight: 0.080 g (typ.)

Circuit Configuration



Note: Note 1, Note 2, Note 3 and Note 4: See the next page.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

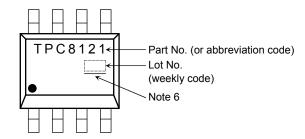
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/ "Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Handle with care.

Thermal Characteristics

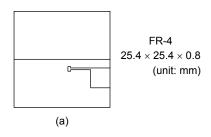
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R _{th (ch-a)}	65.8	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	R _{th (ch-a)}	125	°C/W

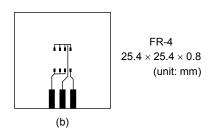
Marking (Note 5)



Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (b) Device mounted on a glass-epoxy board (b)



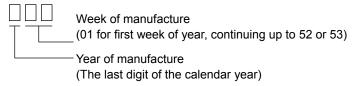


Note 3: $V_{DD} = -24~V$, $T_{ch} = 25^{\circ}C$ (initial), L = 0.5~mH, $R_G = 25~\Omega$, $I_{AR} = -11~A$

Note 4: Repetitive rating: pulse width limited by maximum channel temperature

Note 5: • on the lower left of the marking indicates Pin 1.

* Weekly code: (Three digits)



Note 6: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

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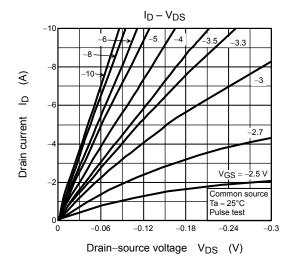
Electrical Characteristics (Ta = 25°C)

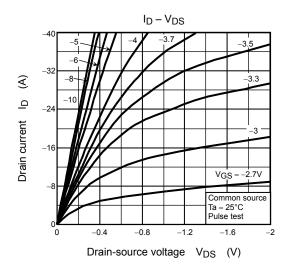
Charact	eristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I _{GSS}	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±100	nA
Drain cut-OFF current		I _{DSS}	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$	_	_	-10	μА
Drain-source breakdown voltage		V _{(BR) DSS}	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-30	_	_	- V
		V _{(BR) DSX}	$I_D = -10 \text{ mA}, V_{GS} = 20 \text{ V}$	-13	_	_	
Gate threshold voltage		V _{th}	$V_{DS} = -10 \text{ V}, I_D = -1 \text{ mA}$	-0.8	_	-2.0	V
Drain-source ON-resistance		D	$V_{GS} = -4 \text{ V}, I_D = -5.5 \text{ A}$	_	16	24	mΩ
		R _{DS} (ON)	$V_{GS} = -10 \text{ V}, I_D = -5.5 \text{ A}$	_	8	12	
Forward transfer admittance		Y _{fs}	$V_{DS} = -10 \text{ V}, I_D = -5.5 \text{ A}$	11	23	_	S
Input capacitance		C _{iss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	_	1770	_	pF
Reverse transfer capacitance		C _{rss}		_	400	_	
Output capacitance		Coss		_	540	_	
Switching time	Rise time	t _r	VGS _ 10 V	_	9	_	- ns
	Turn-ON time	t _{on}		_	15	_	
	Fall time	tf		_	65	_	
	Turn-OFF time	t _{off}	$V_{DD} \approx -15 \text{ V}$ Duty \leq 1%, $t_W = 10 \mu\text{s}$	_	160	_	
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \approx -24 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -11 \text{ A}$	_	42	_	nC
Gate-source charge 1		Q _{gs1}			5		
Gate-drain ("miller") charge		Q _{gd}			13		

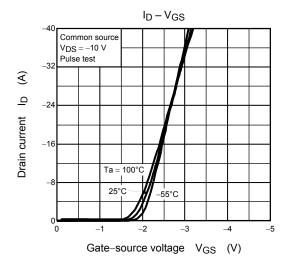
Source-Drain Ratings and Characteristics (Ta = 25°C)

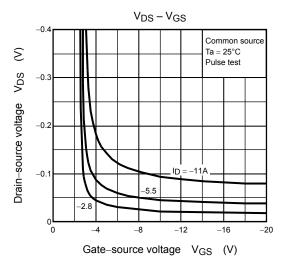
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current Pulse (I	Note 1)	I_{DRP}	_	_	_	-44	Α
Forward voltage (diode)		V_{DSF}	I _{DR} = -11 A, V _{GS} = 0 V	_	_	1.2	V

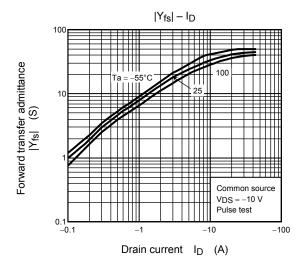
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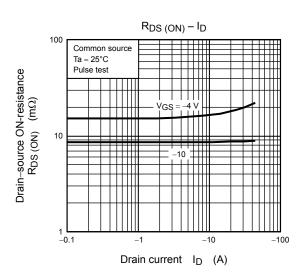


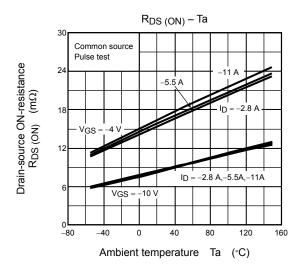


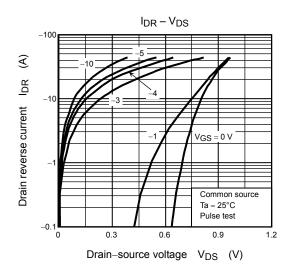


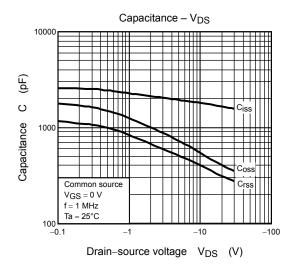


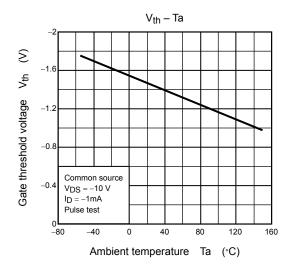


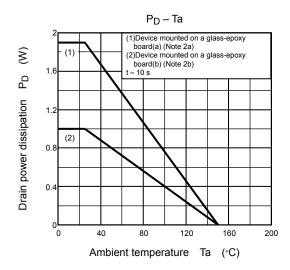


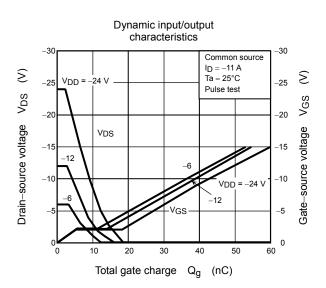


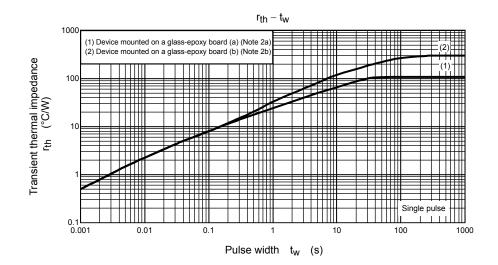


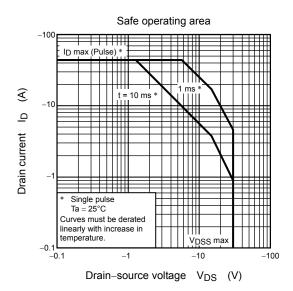












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